

# STGF10M65DF2

# Trench gate field-stop IGBT, M series 650 V, 10 A low-loss in TO-220FP package

Datasheet - production data

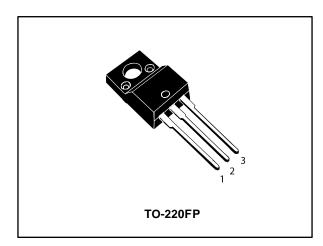
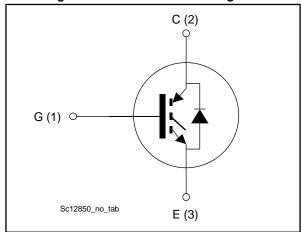


Figure 1: Internal schematic diagram



#### **Features**

- 6 µs of short-circuit withstand time
- $V_{CE(sat)} = 1.55 \text{ V (typ.)} @ I_C = 10 \text{ A}$
- Tight parameter distribution
- Safer paralleling
- Positive V<sub>CE(sat)</sub> temperature coefficient
- Low thermal resistance
- Soft and very fast recovery antiparallel diode
- Maximum junction temperature: T<sub>J</sub> = 175 °C

### **Applications**

- Motor control
- UPS
- PFC
- General purpose inverter

### Description

This device is an IGBT developed using an advanced proprietary trench gate field-stop structure. The device is part of the M series IGBTs, which represent an optimal balance between inverter system performance and efficiency where low-loss and short-circuit functionality are essential. Furthermore, the positive  $V_{\text{CE(sat)}}$  temperature coefficient and tight parameter distribution result in safer paralleling operation.

**Table 1: Device summary** 

Order code	Marking	Package	Packing
STGF10M65DF2	G10M65DF2	TO-220FP	Tube

Contents STGF10M65DF2

# **Contents**

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STGF10M65DF2 Electrical ratings

# 1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit
Vces	Collector-emitter voltage (V <sub>GE</sub> = 0 V)	650	V
Ic <sup>(1)</sup>	Continuous collector current at T <sub>C</sub> = 25 °C	20	Α
Ic <sup>(1)</sup>	Continuous collector current at T <sub>C</sub> = 100 °C	10	Α
Icp <sup>(2)</sup>	Pulsed collector current	40	Α
$V_{GE}$	Gate-emitter voltage	±20	V
I <sub>F</sub> <sup>(1)</sup>	Continuous forward current at T <sub>C</sub> = 25 °C 20		Α
I <sub>F</sub> <sup>(1)</sup>	Continuous forward current at T <sub>C</sub> = 100 °C	10	Α
I <sub>FP</sub> <sup>(2)</sup>	Pulsed forward current	40	Α
Viso	Insulation withstand voltage (RMS) from all three leads to external heat sink (t = 1 s, $T_C$ = 25 °C)	2.5	kV
Ртот	Total dissipation at $T_C = 25$ °C	30	W
T <sub>STG</sub>	Storage temperature range	- 55 to 150	°C
TJ	Operating junction temperature range	- 55 to 175	°C

#### Notes:

Table 3: Thermal data

Symbol	Parameter	Value	Unit
RthJC	Thermal resistance junction-case IGBT	5	°C/W
RthJC	Thermal resistance junction-case diode	6.25	°C/W
R <sub>thJA</sub>	Thermal resistance junction-ambient	62.5	°C/W

<sup>&</sup>lt;sup>(1)</sup>Limited by maximum junction temperature.

 $<sup>\</sup>ensuremath{^{(2)}}\mbox{Pulse}$  width limited by maximum junction temperature.

Electrical characteristics STGF10M65DF2

# 2 Electrical characteristics

 $T_C = 25$  °C unless otherwise specified

**Table 4: Static characteristics** 

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V <sub>(BR)CES</sub>	Collector-emitter breakdown voltage	V <sub>GE</sub> = 0 V, I <sub>C</sub> = 250 μA	650			V
		V <sub>GE</sub> = 15 V, I <sub>C</sub> = 10 A		1.55	2.0	
		V <sub>GE</sub> = 15 V, I <sub>C</sub> = 15 A		1.8		
V <sub>CE(sat)</sub> Collector-emitte voltage	Collector-emitter saturation voltage	V <sub>GE</sub> = 15 V, I <sub>C</sub> = 10 A, T <sub>J</sub> = 125 °C		1.9		V
		V <sub>GE</sub> = 15 V, I <sub>C</sub> = 10 A, T <sub>J</sub> = 175 °C		2.1		
		I <sub>F</sub> = 10 A		1.5	2.25	
VF	Forward on-voltage	I <sub>F</sub> = 10 A, T <sub>J</sub> = 125 °C		1.3		V
		I <sub>F</sub> = 10 A, T <sub>J</sub> = 175 °C		1.2		
V <sub>GE(th)</sub>	Gate threshold voltage	$V_{CE} = V_{GE}$ , $I_C = 250 \mu A$	5	6	7	V
Ices	Collector cut-off current	V <sub>GE</sub> = 0 V, V <sub>CE</sub> = 650 V			25	μΑ
IGES	Gate-emitter leakage current	Vce = 0 V, Vge = ±20 V			±250	μΑ

**Table 5: Dynamic characteristics** 

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Cies	Input capacitance			840	1	
Coes	Output capacitance	V <sub>CE</sub> = 25 V, f = 1 MHz, V <sub>GE</sub> = 0 V	-	63	-	pF
Cres	Reverse transfer capacitance	VGL — V	ı	16	1	
$Q_g$	Total gate charge	$V_{CC} = 520 \text{ V}, I_C = 10 \text{ A},$	-	28	-	
Qge	Gate-emitter charge	V <sub>GE</sub> = 0 to 15 V (see <i>Figure 30: " Gate</i>	ı	6	1	nC
Qgc	Gate-collector charge	charge test circuit")	-	12	-	

STGF10M65DF2 Electrical characteristics

Table 6: IGBT switching characteristics (inductive load)

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t <sub>d(on)</sub>	Turn-on delay time			19	-	ns
tr	Current rise time			7.4	-	ns
(di/dt) <sub>on</sub>	Turn-on current slope	V <sub>CE</sub> = 400 V, I <sub>C</sub> = 10 A,		1086	-	A/µs
t <sub>d(off)</sub>	Turn-off-delay time	$V_{GE} = 15 \text{ V}, R_G = 22 \Omega$		91	-	ns
t <sub>f</sub>	Current fall time	(see Figure 29: " Test circuit for inductive load		92	1	ns
E <sub>on</sub> <sup>(1)</sup>	Turn-on switching energy	switching")		0.12	-	mJ
E <sub>off</sub> <sup>(2)</sup>	Turn-off switching energy			0.27	1	mJ
Ets	Total switching energy			0.39	1	mJ
t <sub>d(on)</sub>	Turn-on delay time			18	-	ns
tr	Current rise time			9	ı	ns
(di/dt) <sub>on</sub>	Turn-on current slope	$V_{CE} = 400 \text{ V}, I_{C} = 10 \text{ A},$ $V_{GE} = 15 \text{ V}, R_{G} = 22 \Omega$		890	-	A/µs
t <sub>d(off)</sub>	Turn-off-delay time	T <sub>J</sub> = 175 °C		90	1	ns
t <sub>f</sub>	Current fall time	(see Figure 29: " Test		170	ı	ns
E <sub>on</sub> <sup>(1)</sup>	Turn-on switching energy	circuit for inductive load switching")		0.26	ı	mJ
E <sub>off</sub> <sup>(2)</sup>	Turn-off switching energy	,		0.4	ı	mJ
E <sub>ts</sub>	Total switching energy			0.66	-	mJ
	Chart aircuit withstand time	V <sub>CC</sub> ≤ 400 V, V <sub>GE</sub> = 13 V, T <sub>Jstart</sub> = 150 °C	10		-	μs
t <sub>sc</sub>	Short-circuit withstand time	V <sub>CC</sub> ≤ 400 V, V <sub>GE</sub> = 15 V, T <sub>Jstart</sub> = 150 °C	6		-	μs

#### Notes:

Table 7: Diode switching characteristics (inductive load)

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t <sub>rr</sub>	Reverse recovery time	1 40 4 1/ 400 1/	-	96	ı	ns
$Q_{rr}$	Reverse recovery charge	$I_F = 10 \text{ A}, V_R = 400 \text{ V},$ $V_{GE} = 15 \text{ V},$	-	373	ı	nC
I <sub>rrm</sub>	Reverse recovery current	di/dt = 1000 A/µs	-	13	ı	Α
dl <sub>rr</sub> /dt	Peak rate of fall of reverse recovery current during t <sub>b</sub> (see Figure 29: "Test circuit for inductive load switching")		-	661	ı	A/µs
Err	Reverse recovery energy	Switching )	-	52	ı	μJ
t <sub>rr</sub>	Reverse recovery time $I_F = 10 \text{ A}, V_R = 400 \text{ V},$		-	201	•	ns
Qrr	Reverse recovery charge	V <sub>GE</sub> = 15 V,	-	1352	ı	nC
I <sub>rrm</sub>	Reverse recovery current	di/dt = 1000 A/μs, Tɹ = 175 °C	-	19	ı	Α
dl <sub>rr</sub> /dt	Peak rate of fall of reverse recovery current during t <sub>b</sub>	(see Figure 29: " Test circuit for inductive load	-	405	ı	A/µs
Err	Reverse recovery energy	switching")	-	150	-	μJ

<sup>&</sup>lt;sup>(1)</sup>Including the reverse recovery of the diode.

 $<sup>\</sup>ensuremath{^{(2)}}\mbox{Including}$  the tail of the collector current.

# 2.1 Electrical characteristics (curves)

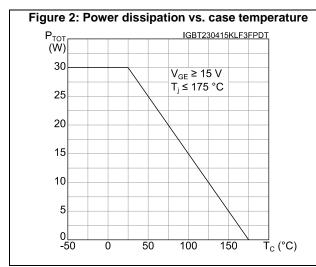


Figure 4: Output characteristics (T<sub>J</sub> = 25 °C)

I<sub>C</sub>

(A)

V<sub>GE</sub> = 15 V

13 V

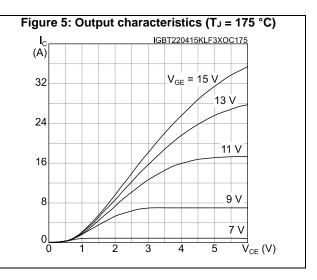
16

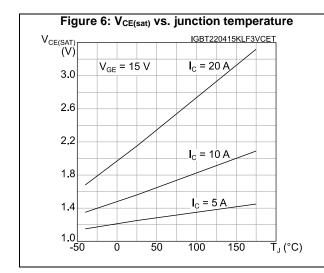
11 V

16

9 V

0 1 2 3 4 5 V<sub>CE</sub> (V)





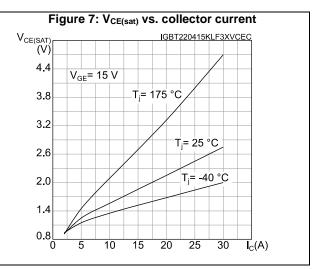
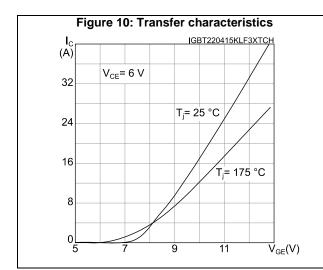
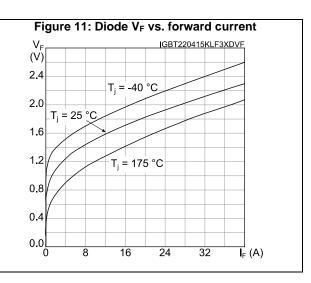
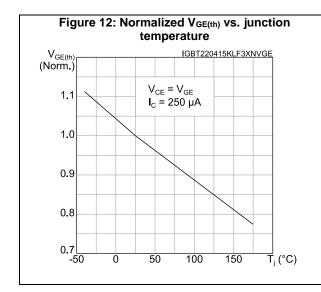
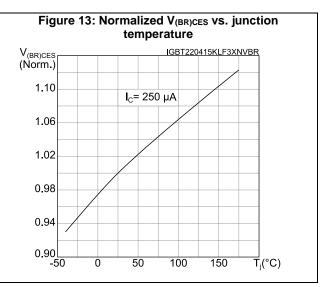


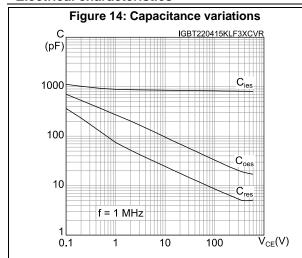
Figure 9: Forward bias safe operating area I<sub>C</sub> IGBT230415KLF3FFSOA (A)  $t_p=1 \text{ } \mu \text{s}$   $t_p=10 \text{ } \mu \text{s}$   $t_p=100 \text{ } \mu \text{$ 

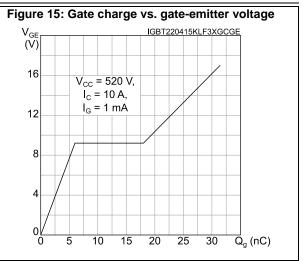


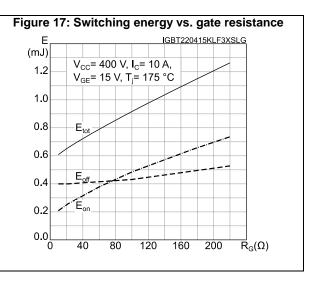


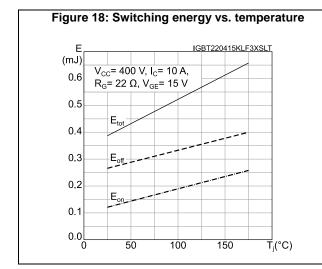


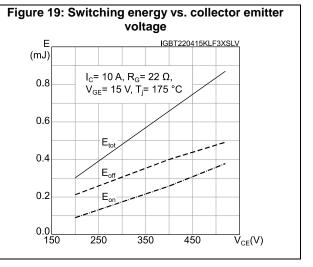






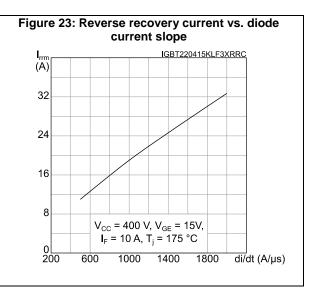


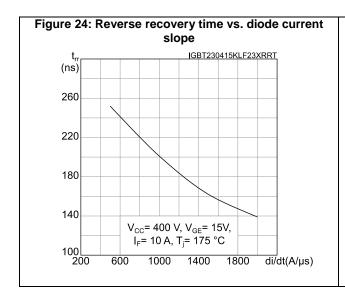


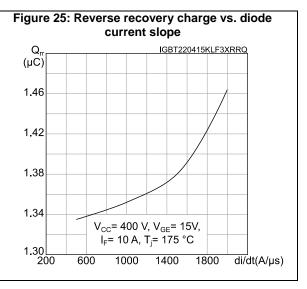


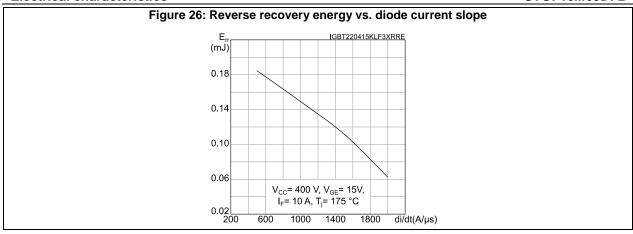
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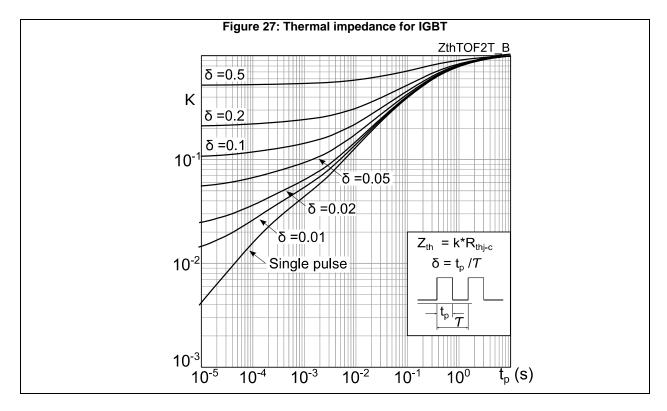
Figure 20: Short-circuit time and current vs. VGE ne anu Carlos IGBT220415KLF3XSCV ISC (A) V<sub>CC</sub>≤ 400 V T<sub>i</sub>≤ 150 °C sc 9  $\overline{V}_{GE}(V)$ 



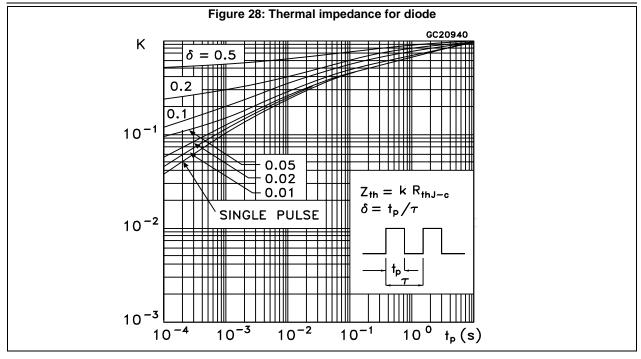






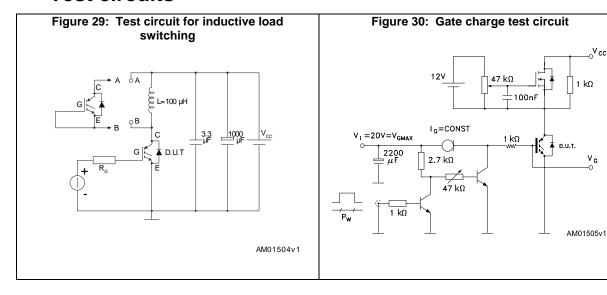


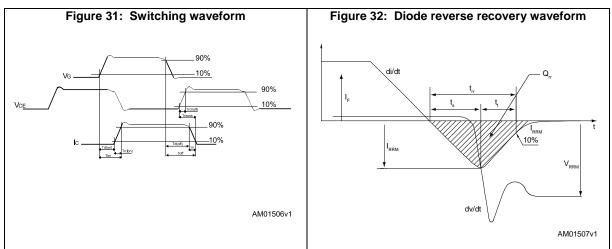
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Test circuits STGF10M65DF2

# 3 Test circuits





STGF10M65DF2 Package information

# 4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: **www.st.com**. ECOPACK® is an ST trademark.



# 4.1 TO-220FP package information

Figure 33: TO-220FP package outline

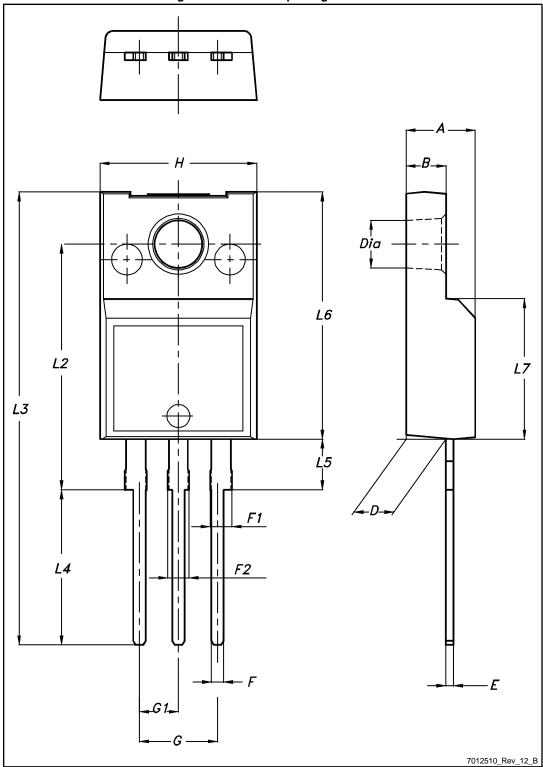


Table 8: TO-220FP package mechanical data

Dim.		mm	
Dilli.	Min.	Тур.	Max.
Α	4.4		4.6
В	2.5		2.7
D	2.5		2.75
Е	0.45		0.7
F	0.75		1
F1	1.15		1.70
F2	1.15		1.70
G	4.95		5.2
G1	2.4		2.7
Н	10		10.4
L2		16	
L3	28.6		30.6
L4	9.8		10.6
L5	2.9		3.6
L6	15.9		16.4
L7	9		9.3
Dia	3		3.2

Revision history STGF10M65DF2

# 5 Revision history

Table 9: Document revision history

Date	Revision	Changes
10-Feb-2015	1	First release.
23-Apr-2015	2	Minor text edits throughout document In Section 2 Electrical characteristics: - updated Table 4: Static characteristics - updated Table 5: Dynamic characteristics - updated Table 6: IGBT switching characteristics (inductive load) - updated Table 7: Diode switching characteristics (inductive load) Added Section 2.1 Electrical characteristics (curves)
31-Jul-2015	3	Updated table titled "Diode switching characteristics (inductive load)"
19-Oct-2015	4	Updated Table 5: "Dynamic characteristics" and Table 6: "IGBT switching characteristics (inductive load)".  Changed Figure 27: "Thermal impedance for IGBT".
21-Oct-2015	5	Updated Table 4: "Static characteristics"
08-Feb-2016	6	Datasheet promoted from preliminary data to production data Minor text changes
07-Apr-2017	7	Modified title, features and applications on cover page.  Modified Table 4: "Static characteristics", Table 6: "IGBT switching characteristics (inductive load)" and Table 7: "Diode switching characteristics (inductive load)"  Minor text changes.

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 VS-CPV364M4KPBF
 NGTB25N120FL2WAG
 NGTG40N120FL2WG
 RJH60F3DPQ-A0#T0

 APT40GR120B2SCD10
 APT15GT120BRG
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 NGTB75N65FL2WAG
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 IXA30RG1200DHGLB

 IXA40RG1200DHGLB
 APT70GR65B2DU40
 NTE3320
 IHFW40N65R5SXKSA1
 APT70GR120J
 APT35GP120JDQ2

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 IKFW75N65ES5XKSA1
 IKFW50N65ES5XKSA1
 IKFW50N65EH5XKSA1
 IKFW40N65ES5XKSA1

 IKFW60N65ES5XKSA1
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 IMBG120R220M1HXTMA1
 XD15H120CX1
 XD25H120CX0
 XP15PJS120CL1B1

 IGW30N60H3FKSA1
 STGWA15H120F2
 IKA10N60TXKSA1
 IHW20N120R5XKSA1
 RJH60D2DPP-M0#T2
 IKP20N60TXKSA1

 IHW20N65R5XKSA1
 IDW40E65D2FKSA1
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